

# TOSHIBA MOS MEMORY PRODUCT

1,048,576 WORDS × 1 BIT DYNAMIC RAM  
SILICON GATE CMOS

TC511000P/J/Z-85, TC511000P/J/Z-10  
TC511000P/J/Z-12

## DESCRIPTION

The TC511000P/J/Z is the new generation dynamic RAM organized 1,048,576 words by 1 bit. The TC511000P/J/Z utilizes TOSHIBA's CMOS Silicon gate process technology as well as advanced circuit techniques to provide wide operating margins, both internally and to the system user. Multiplexed address inputs permit the TC511000P/J/Z to be packaged in a standard 18 pin plastic DIP, 26/20 pin plastic SOJ and 20/19 pin plastic ZIP. The package size provides high system bit densities and is compatible with widely available automated testing and insertion equipment. System oriented features include single power supply of  $5V \pm 10\%$  tolerance, direct interfacing capability with high performance logic families such as Schottky TTL. "Test Mode" function is implemented from Revision C.

## FEATURES

- 1,048,576 words by 1 bit organization
- Fast access time and cycle time

		TC511000P/J/Z-85-10-12		
$t_{RAC}$	RAS Access Time	85ns	100ns	120ns
$t_{AA}$	Column Address Access Time	45ns	50ns	60ns
$t_{CAC}$	CAS Access Time	25ns	25ns	30ns
$t_{RC}$	Cycle Time	165ns	190ns	220ns
$t_{PC}$	Fast Page Mode Cycle Time	50ns	55ns	70ns

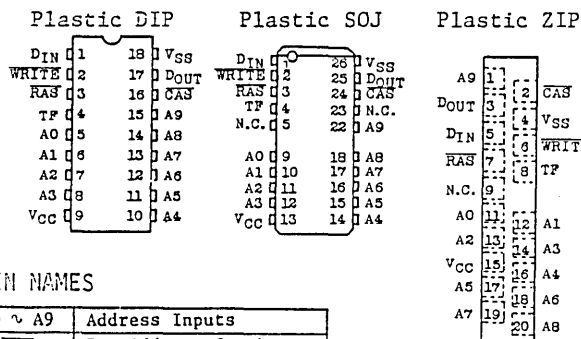
- Single power supply of  $5V \pm 10\%$  with a built-in  $V_{BB}$  generator

- Low Power

385mW MAX. Operating (TC511000P/J/Z-85)  
330mW MAX. Operating (TC511000P/J/Z-10)  
275mW MAX. Operating (TC511000P/J/Z-12)  
5.5mW MAX. Standby

- Output unlatched at cycle end allows two-dimensional chip selection
- Common I/O capability using "EARLY WRITE" operation
- Read-Modify-Write,  $\overline{CAS}$  before  $\overline{RAS}$  refresh, RAS-only refresh, Hidden refresh, Fast Page Mode and Test Mode capability
- All inputs and output TTL compatible
- 512 refresh cycles/8ms
- Package Plastic DIP: TC511000P  
Plastic SOJ: TC511000J  
Plastic ZIP: TC511000Z

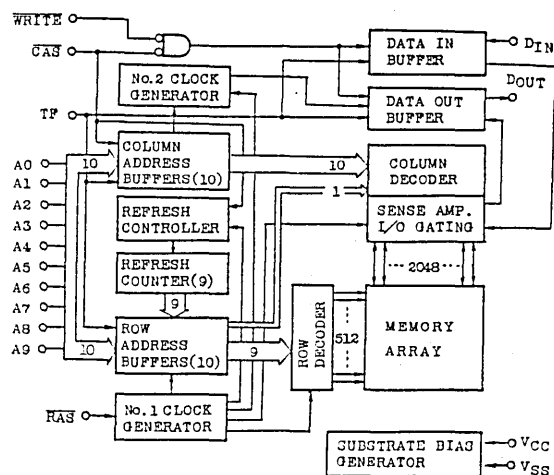
## PIN CONNECTION (TOP VIEW)



## PIN NAMES

A0 ~ A9	Address Inputs
RAS	Row Address Strobe
DIN	Data In
DOUT	Data Out
CAS	Column Address Strobe
WRITE	Read/Write Input
VCC	Power (+5V)
VSS	Ground
TF	Test Function
N.C.	No Connection

## BLOCK DIAGRAM



# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

## ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	RATING	UNITS	NOTES
Input Voltage	V <sub>IN</sub>	-1 ~ 7	V	1
Test Function Input Voltage	V <sub>IN</sub> (TF)	-1 ~ 10.5	V	1
Output Voltage	V <sub>OUT</sub>	-1 ~ 7	V	1
Power Supply Voltage	V <sub>CC</sub>	-1 ~ 7	V	1
Operating Temperature	T <sub>OPR</sub>	0 ~ 70	°C	1
Storage Temperature	T <sub>STG</sub>	-55 ~ 150	°C	1
Soldering Temperature • Time	T <sub>SOLDER</sub>	260 • 10	°C • sec	1
Power Dissipation	PD	600	mW	1
Short Circuit Output Current	I <sub>OUT</sub>	50	mA	1

## RECOMMENDED DC OPERATING CONDITIONS (T<sub>a</sub>=0 ~ 70°C)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT	NOTES
V <sub>CC</sub>	Supply Voltage	4.5	5.0	5.5	V	2
V <sub>IH</sub>	Input High Voltage	2.4	-	6.5	V	2
V <sub>IL</sub>	Input Low Voltage	-1.0	-	0.8	V	2
V <sub>IH</sub> (TF)	Test Enable Input High Voltage	V <sub>CC</sub> +4.5	-	10.5	V	2

## DC ELECTRICAL CHARACTERISTICS (V<sub>CC</sub>=5V±10%, T<sub>a</sub>=0 ~ 70°C)

SYMBOL	PARAMETER	MIN.	MAX.	UNITS	NOTES
I <sub>CC1</sub>	OPERATING CURRENT	TC511000P/J/Z-85	-	70	mA 3,4
	Average Power Supply Operating Current (R <sub>AS</sub> , C <sub>AS</sub> , Address Cycling: t <sub>RC</sub> =t <sub>RC</sub> MIN.)	TC511000P/J/Z-10	-	60	
		TC511000P/J/Z-12	-	50	
I <sub>CC2</sub>	STANDBY CURRENT				mA
	Power Supply Standby Current (R <sub>AS</sub> =C <sub>AS</sub> =V <sub>IH</sub> )	-	2		
I <sub>CC3</sub>	R <sub>AS</sub> ONLY REFRESH CURRENT	TC511000P/J/Z-85	-	70	mA 3
	Average Power Supply Current, R <sub>AS</sub> Only Mode (R <sub>AS</sub> Cycling, C <sub>AS</sub> =V <sub>IH</sub> : t <sub>RC</sub> =t <sub>RC</sub> MIN.)	TC511000P/J/Z-10	-	60	
		TC511000P/J/Z-12	-	50	
I <sub>CC4</sub>	FAST PAGE MODE CURRENT	TC511000P/J/Z-85	-	50	mA 3,4
	Average Power Supply Current, Fast Page Mode (R <sub>AS</sub> =V <sub>IL</sub> , C <sub>AS</sub> , Address Cycling: t <sub>PC</sub> =t <sub>PC</sub> MIN.)	TC511000P/J/Z-10	-	40	
		TC511000P/J/Z-12	-	30	
I <sub>CC5</sub>	STANDBY CURRENT				mA
	Power Supply Standby Current (R <sub>AS</sub> =C <sub>AS</sub> =V <sub>CC</sub> -0.2V)	-	1		
I <sub>CC6</sub>	C <sub>AS</sub> BEFORE R <sub>AS</sub> REFRESH CURRENT	TC511000P/J/Z-85	-	70	mA 3
	Average Power Supply Current, C <sub>AS</sub> Before R <sub>AS</sub> Mode (R <sub>AS</sub> , C <sub>AS</sub> Cycling: t <sub>RC</sub> =t <sub>RC</sub> MIN.)	TC511000P/J/Z-10	-	60	
		TC511000P/J/Z-12	-	50	
I <sub>I</sub> (L)	INPUT LEAKAGE CURRENT (any input except TF)				μA
	Input Leakage Current, any input (0V ≤ V <sub>IN</sub> ≤ 6.5V, All Other Pins Not Under Test=0V)	-10	10		
I <sub>ITF</sub> (L)	INPUT LEAKAGE CURRENT (only TF) (0V ≤ V <sub>IN</sub> (TF) ≤ 0.8V, All Other Pins Not Under Test=0V)	-10	10		μA
I <sub>O</sub> (L)	OUTPUT LEAKAGE CURRENT (D <sub>OUT</sub> is disabled, 0V ≤ V <sub>OUT</sub> ≤ 5.5V)	-10	10		μA
I <sub>TF</sub>	TEST FUNCTION INPUT CURRENT (V <sub>CC</sub> +4.5V ≤ V <sub>IN</sub> (TF) ≤ 10.5V)	-	1		mA
V <sub>OH</sub>	OUTPUT LEVEL Output "H" Level Voltage (I <sub>OUT</sub> =-5mA)	2.4	-		V
V <sub>OL</sub>	OUTPUT LEVEL Output "L" Level Voltage (I <sub>OUT</sub> =4.2mA)	-	0.4		V

# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

## ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

(V<sub>CC</sub>=5V±10%, T<sub>a</sub>=0~70°C) (Notes 5, 6, 7)

SYMBOL	PARAMETER	TC511000P/J/Z-85		TC511000P/J/Z-10		TC511000P/J/Z-12		UNIT	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t <sub>RC</sub>	Random Read or Write Cycle Time	165	-	190	-	220	-	ns	
t <sub>RWC</sub>	Read-Write Cycle Time	190	-	220	-	255	-	ns	
t <sub>PC</sub>	Fast Page Mode Cycle Time	50	-	55	-	70	-	ns	
t <sub>PRWC</sub>	Fast Page Mode Read-Write Cycle Time	75	-	85	-	105	-	ns	
t <sub>RAC</sub>	Access Time from $\overline{\text{RAS}}$	-	85	-	100	-	120	ns	8,13
t <sub>CAC</sub>	Access Time from $\overline{\text{CAS}}$	-	25	-	25	-	30	ns	8,13
t <sub>AA</sub>	Access Time from Column Address	-	45	-	50	-	60	ns	8,14
t <sub>CPA</sub>	Access Time from $\overline{\text{CAS}}$ Precharge	-	45	-	50	-	65	ns	8
t <sub>CLZ</sub>	$\overline{\text{CAS}}$ to Output in Low-Z	5	-	5	-	5	-	ns	8
t <sub>OFF</sub>	Output Buffer Turn-off Delay	0	30	0	30	0	35	ns	9
t <sub>T</sub>	Transition Time (Rise and Fall)	3	50	3	50	3	50	ns	7
t <sub>RP</sub>	$\overline{\text{RAS}}$ Precharge Time	70	-	80	-	90	-	ns	
t <sub>RAS</sub>	$\overline{\text{RAS}}$ Pulse Width	85	10,000	100	10,000	120	10,000	ns	
t <sub>RASP</sub>	$\overline{\text{RAS}}$ Pulse Width (Fast Page Mode)	85	100,000	100	100,000	120	100,000	ns	
t <sub>RSH</sub>	$\overline{\text{RAS}}$ Hold Time	25	-	25	-	30	-	ns	
t <sub>CSH</sub>	$\overline{\text{CAS}}$ Hold Time	85	-	100	-	120	-	ns	
t <sub>CAS</sub>	$\overline{\text{CAS}}$ Pulse Width	25	10,000	25	10,000	30	10,000	ns	
t <sub>RCD</sub>	$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Delay Time	25	60	25	75	25	90	ns	13
t <sub>RAD</sub>	$\overline{\text{RAS}}$ to Column Address Delay Time	20	40	20	50	20	60	ns	14
t <sub>CRP</sub>	$\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ Precharge Time	10	-	10	-	10	-	ns	
t <sub>CP</sub>	$\overline{\text{CAS}}$ Precharge Time (Fast Page Mode)	10	-	10	-	15	-	ns	
t <sub>ASR</sub>	Row Address Set-Up Time	0	-	0	-	0	-	ns	
t <sub>RAH</sub>	Row Address Hold Time	15	-	15	-	15	-	ns	
t <sub>ASC</sub>	Column Address Set-Up Time	0	-	0	-	0	-	ns	
t <sub>CAH</sub>	Column Address Hold Time	20	-	20	-	25	-	ns	
t <sub>AR</sub>	Column Address Hold Time referenced to $\overline{\text{RAS}}$	65	-	75	-	90	-	ns	
t <sub>RAL</sub>	Column Address to $\overline{\text{RAS}}$ Lead Time	45	-	50	-	60	-	ns	
t <sub>RCS</sub>	Read Command Set-Up Time	0	-	0	-	0	-	ns	
t <sub>RCH</sub>	Read Command Hold Time	0	-	0	-	0	-	ns	10
t <sub>RRH</sub>	Read Command Hold Time referenced to $\overline{\text{RAS}}$	0	-	0	-	0	-	ns	10

# **TC511000P/J/Z-85, TC511000P/J/Z-10** **TC511000P/J/Z-12**

## **ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS (Continued)**

SYMBOL	PARAMETER	TC511000P/J/Z-85		TC511000P/J/Z-10		TC511000P/J/Z-12		UNITS	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
$t_{WCH}$	Write Command Hold Time	20	-	20	-	25	-	ns	
$t_{WCR}$	Write Command Hold Time referenced to $\overline{RAS}$	65	-	75	-	90	-	ns	
$t_{WP}$	Write Command Pulse Width	20	-	20	-	25	-	ns	
$t_{RWL}$	Write Command to $\overline{RAS}$ Lead Time	20	-	25	-	30	-	ns	
$t_{CWL}$	Write Command to $\overline{CAS}$ Lead Time	20	-	25	-	30	-	ns	
$t_{DS}$	Data Set-Up Time	0	-	0	-	0	-	ns	11
$t_{DH}$	Data Hold Time	20	-	20	-	25	-	ns	11
$t_{DHR}$	Data Hold Time referenced to $\overline{RAS}$	65	-	75	-	90	-	ns	
$t_{REF}$	Refresh Period	-	8	-	8	-	8	ms	
$t_{WCS}$	Write Command Set-Up Time	0	-	0	-	0	-	ns	12
$t_{CWD}$	$\overline{CAS}$ to $\overline{WRITE}$ Delay Time	25	-	25	-	30	-	ns	12
$t_{RWD}$	$\overline{RAS}$ to $\overline{WRITE}$ Delay Time	85	-	100	-	120	-	ns	12
$t_{AWD}$	Column Address to $\overline{WRITE}$ Delay Time	45	-	50	-	60	-	ns	12
$t_{CSR}$	$\overline{CAS}$ Set-Up Time ( $\overline{CAS}$ before $\overline{RAS}$ Cycle)	10	-	10	-	10	-	ns	
$t_{CHR}$	$\overline{CAS}$ Hold Time ( $\overline{CAS}$ before $\overline{RAS}$ Cycle)	30	-	30	-	30	-	ns	
$t_{RPC}$	$\overline{RAS}$ to $\overline{CAS}$ Precharge Time	0	-	0	-	0	-	ns	
$t_{CPT}$	$\overline{CAS}$ Precharge Time ( $\overline{CAS}$ before $\overline{RAS}$ Counter Test Cycle)	50	-	50	-	60	-	ns	
$t_{CPN}$	$\overline{CAS}$ Precharge Time	15	-	15	-	20	-	ns	
$t_{TES}$	Test Mode Enable Set-Up Time referenced to $\overline{RAS}$	0	-	0	-	0	-	ns	
$t_{TEH}$	Test Mode Enable Hold Time referenced to $\overline{RAS}$	0	-	0	-	0	-	ns	

# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

CAPACITANCE ( $V_{CC}=5V\pm10\%$ ,  $f=1\text{MHz}$ ,  $T_a=0\sim70^\circ\text{C}$ )

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
C <sub>I1</sub>	Input Capacitance (A0 ~ A9, D <sub>IN</sub> )	-	5	pF
C <sub>I2</sub>	Input Capacitance ( $\overline{\text{RAS}}$ , $\overline{\text{CAS}}$ , $\overline{\text{WRITE}}$ , TF)	-	7	
C <sub>O</sub>	Output Capacitance (D <sub>OUT</sub> )	-	7	

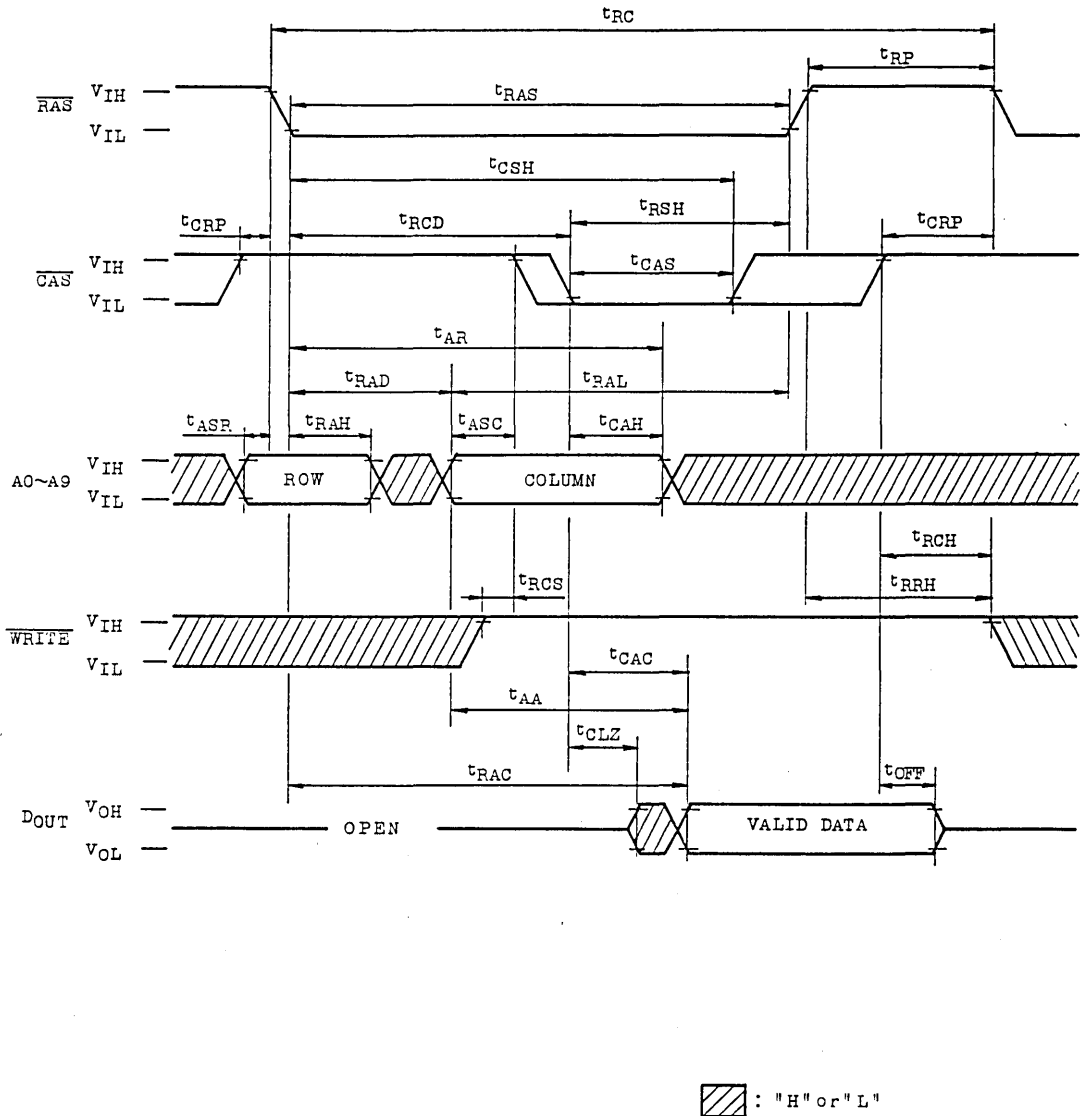
## NOTES:

- Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.
- All Voltages are referenced to  $V_{SS}$ .
- $I_{CC1}$ ,  $I_{CC3}$ ,  $I_{CC4}$ ,  $I_{CC6}$  depend on cycle rate.
- $I_{CC1}$ ,  $I_{CC4}$  depend on output loading. Specified values are obtained with the output open.
- An initial pause of 200 $\mu\text{s}$  is required after power-up followed by 8  $\overline{\text{RAS}}$  cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8  $\overline{\text{CAS}}$  before  $\overline{\text{RAS}}$  initialization cycles instead of 8  $\overline{\text{RAS}}$  cycles are required.
- AC measurements assume  $t_T=5\text{ns}$ .
- $V_{IH}(\text{min.})$  and  $V_{IL}(\text{max.})$  are reference levels for measuring timing of input signals. Also, transition times are measured between  $V_{IH}$  and  $V_{IL}$ .
- Measured with a load equivalent to 2 TTL loads and 100pF.
- $t_{OFF}(\text{max.})$  defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
- Either  $t_{RCH}$  or  $t_{RRH}$  must be satisfied for a read cycle.
- These parameters are referenced to  $\overline{\text{CAS}}$  leading edge in early write cycles and to  $\overline{\text{WRITE}}$  leading edge in read-write cycles.
- $t_{WCS}$ ,  $t_{RWD}$ ,  $t_{CWD}$  and  $t_{AWD}$  are not restrictive operating parameters. They are included the data sheet as electrical characteristics only. If  $t_{WCS} \geq t_{WCS}(\text{min.})$ , the cycle is an early write cycle and data out pin will remain open circuit (high impedance) through the entire cycle; If  $t_{RWD} \geq t_{RWD}(\text{min.})$ ,  $t_{CWD} \geq t_{CWD}(\text{min.})$  and  $t_{AWD} \geq t_{AWD}(\text{min.})$ , the cycle is a read-write cycle and data out will contain data read from the selected cell: If neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
- Operation within the  $t_{RCD}(\text{max.})$  limit insures that  $t_{RAC}(\text{max.})$  can be met.  $t_{RCD}(\text{max.})$  is specified as a reference point only: If  $t_{RCD}$  is greater than the specified  $t_{RCD}(\text{max.})$  limit, then access time is controlled by  $t_{CAC}$ .
- Operation within the  $t_{RAD}(\text{max.})$  limit insures that  $t_{RAC}(\text{max.})$  can be met.  $t_{RAD}(\text{max.})$  is specified as a reference point only: If  $t_{RAD}$  is greater then the specified  $t_{RAD}(\text{max.})$  limit, then access time is controlled by  $t_{AA}$ .

# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

## TIMING WAVEFORMS

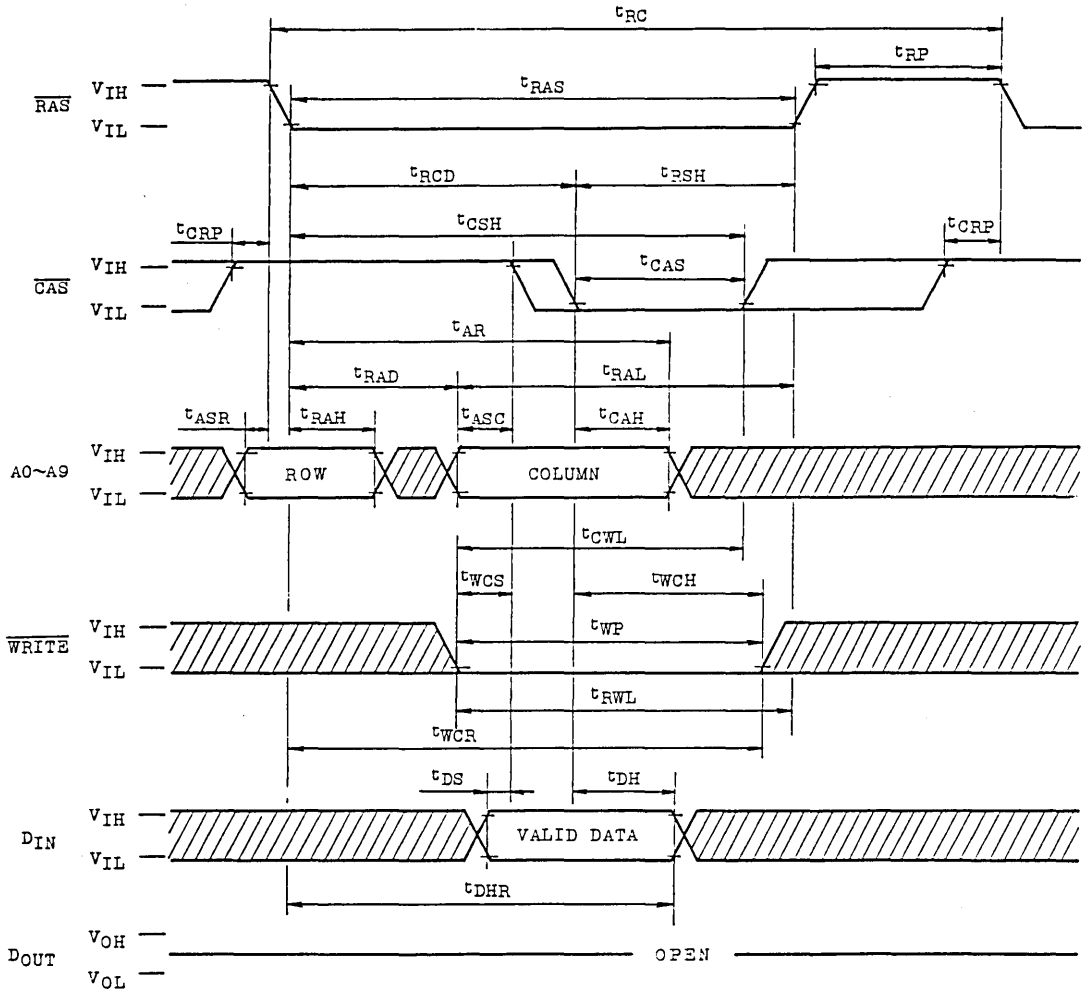
### READ CYCLE




NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

**TC511000P/J/Z-85, TC511000P/J/Z-10  
TC511000P/J/Z-12**

WRITE CYCLE (EARLY WRITE)

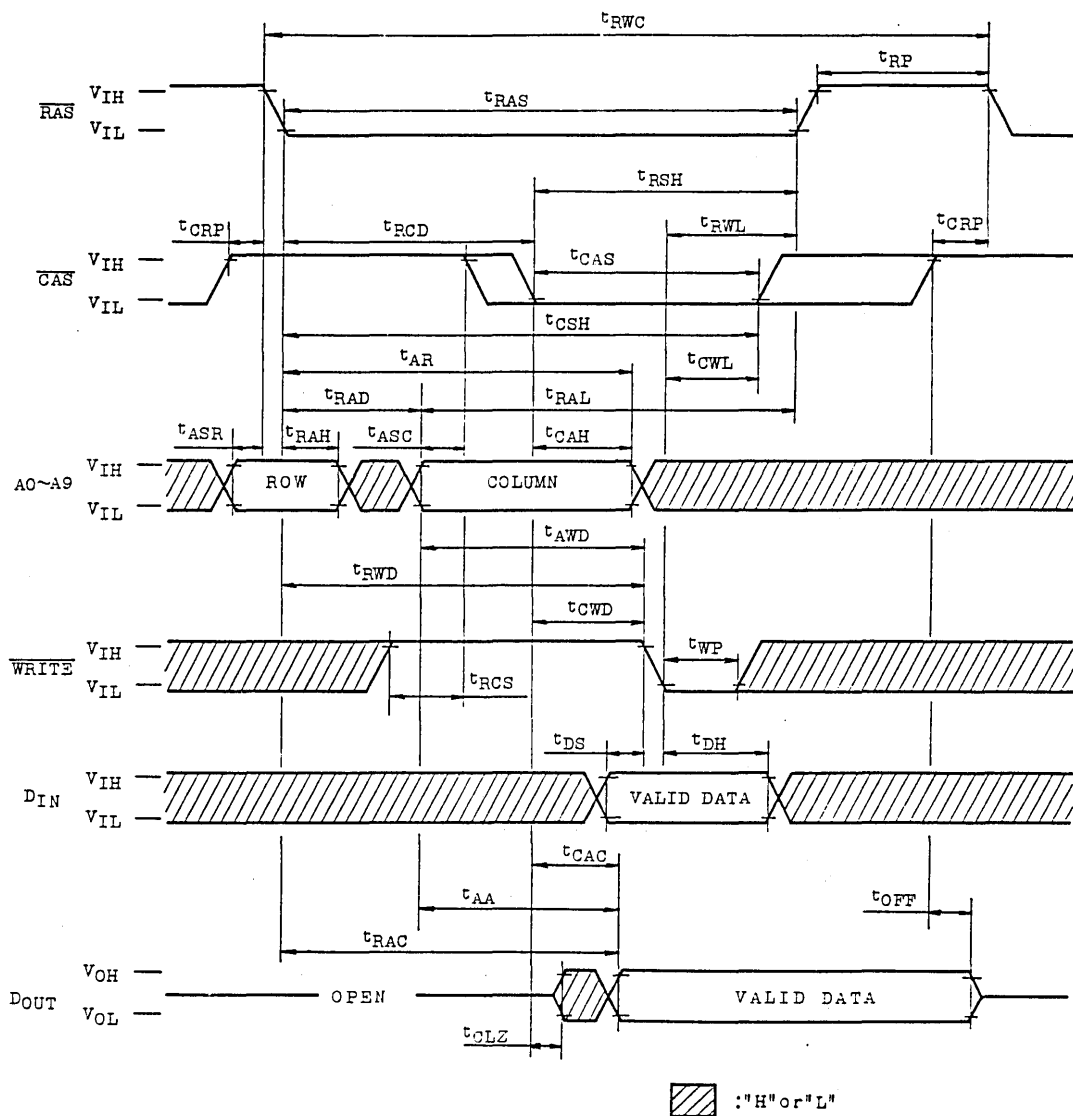


 : "H" or "L"

NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

# **TC511000P/J/Z-85, TC511000P/J/Z-10** **TC511000P/J/Z-12**

## READ-WRITE CYCLE

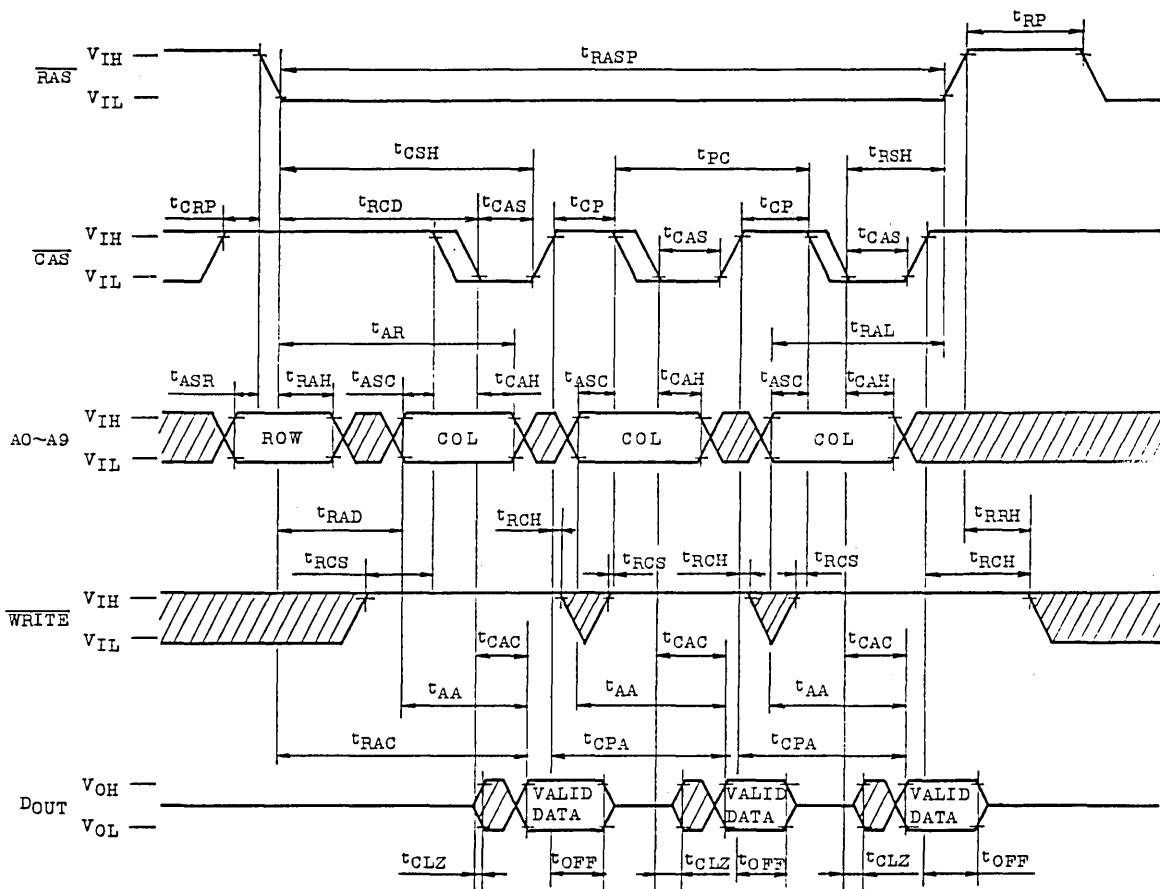



NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.



**TC511000P/J/Z-85, TC511000P/J/Z-10  
TC511000P/J/Z-12**

FAST PAGE MODE READ CYCLE

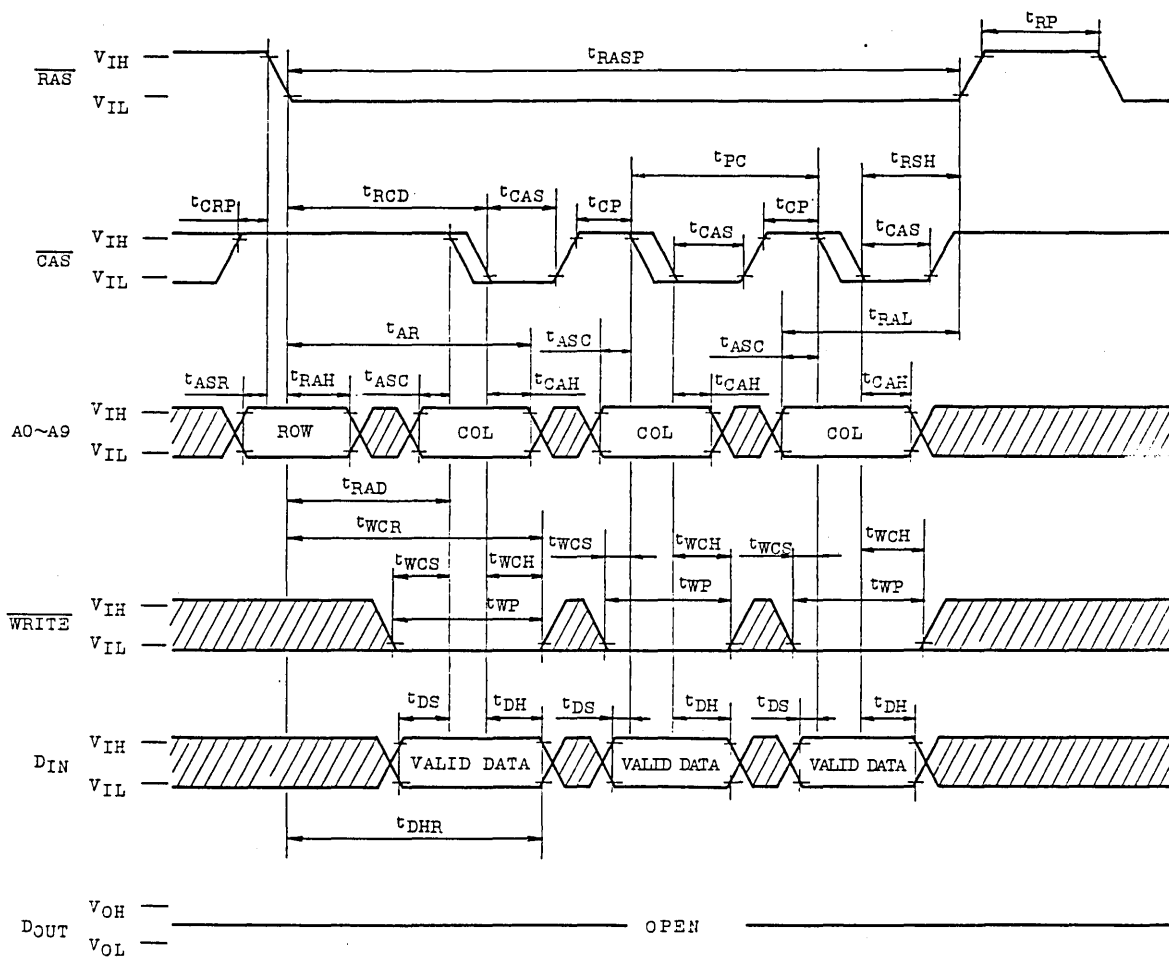


 : "H" or "L"

NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

**TC511000P/J/Z-85, TC511000P/J/Z-10**  
**TC511000P/J/Z-12**

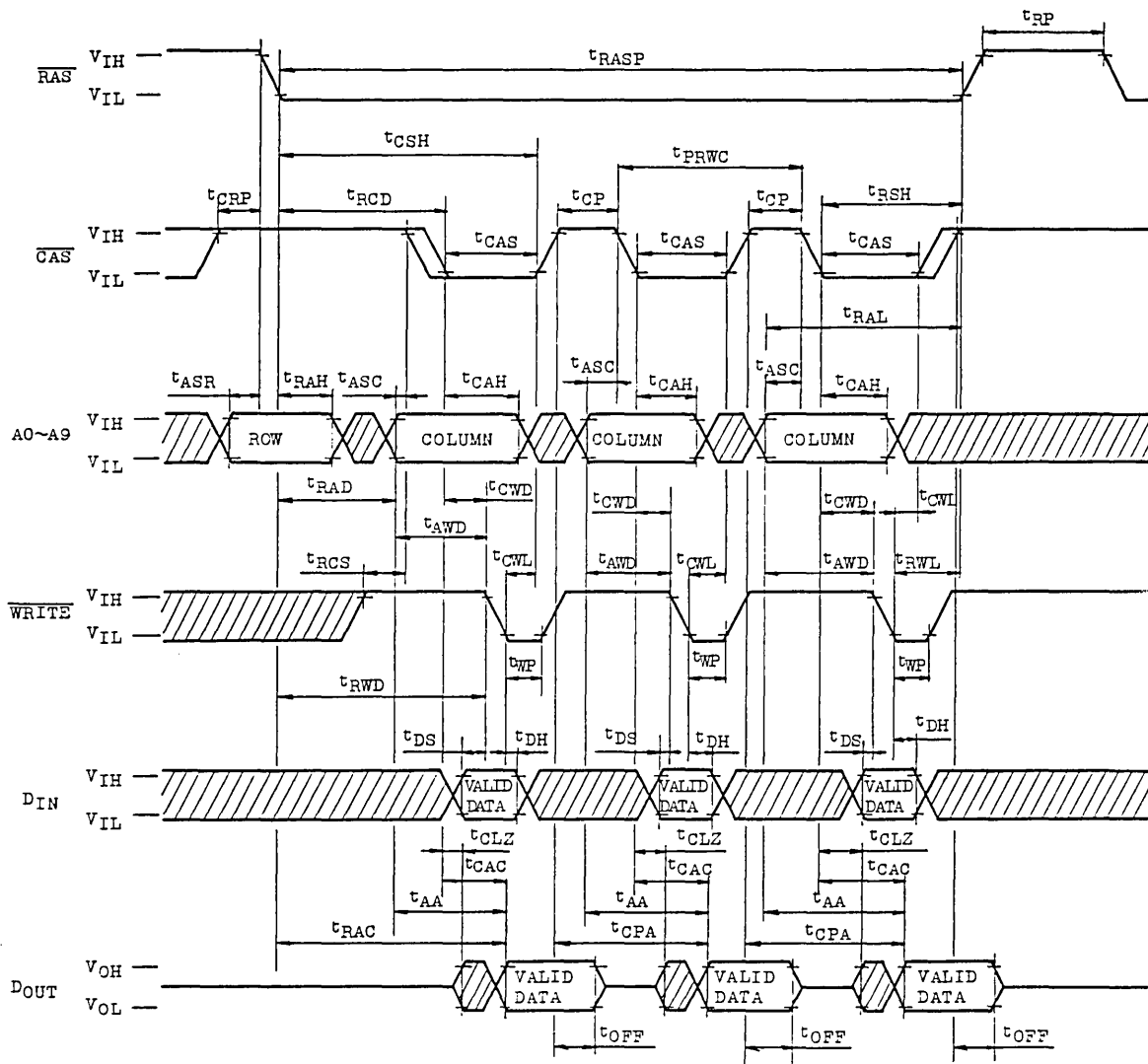
FAST PAGE MODE WRITE CYCLE (EARLY WRITE)



NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

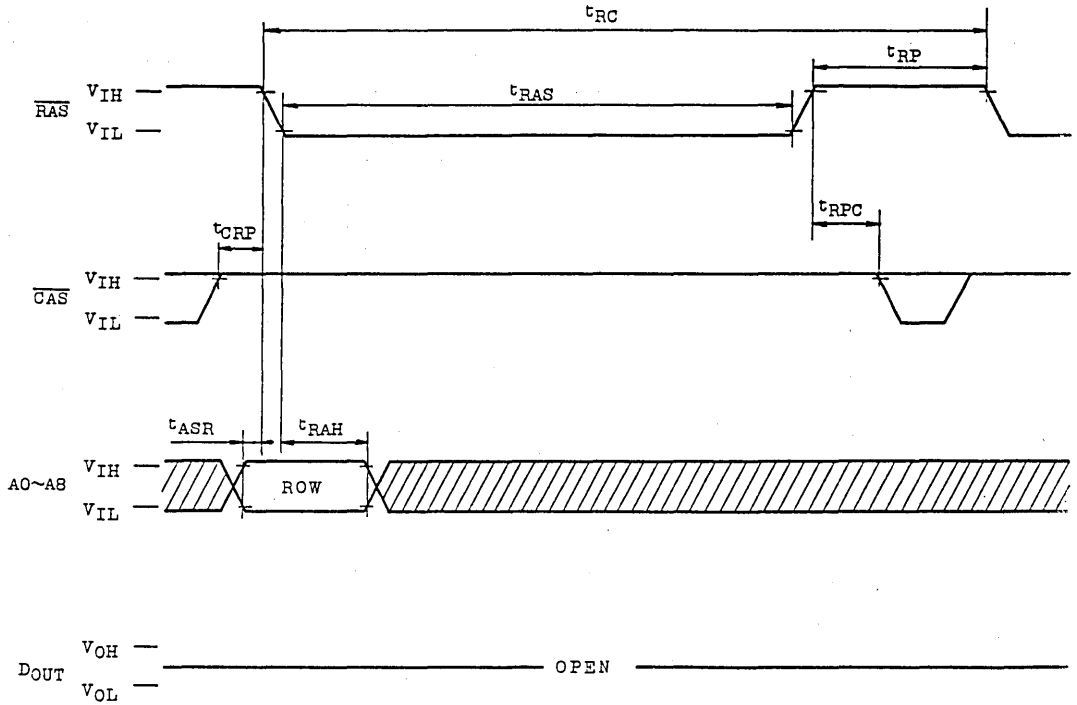
## FAST PAGE MODE READ-WRITE CYCLE




NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

**TC511000P/J/Z-85, TC511000P/J/Z-10**  
**TC511000P/J/Z-12**

**RAS ONLY REFRESH CYCLE**



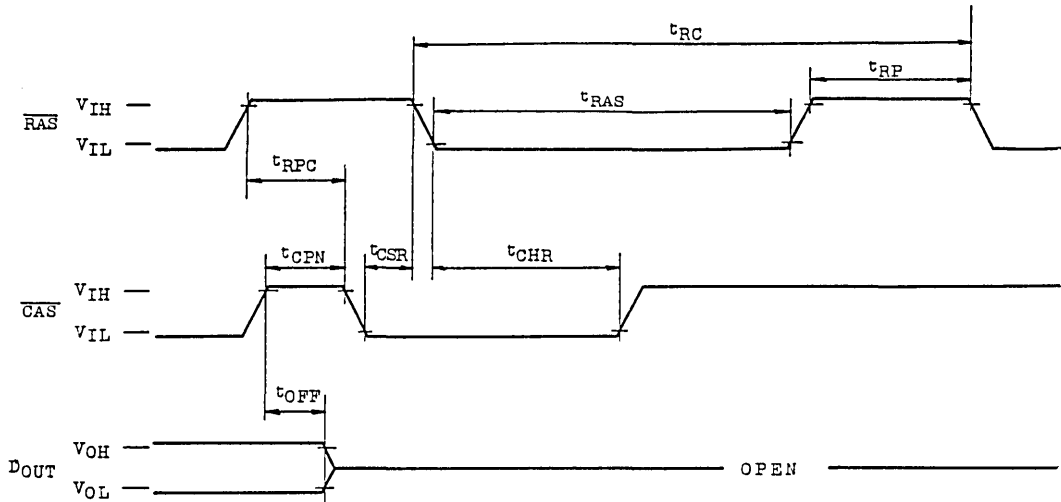
 : "H" or "L"


NOTE:  $\overline{WRITE}$ ="H" or "L", A9="H" or "L"

"TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

**TC511000P/J/Z-85, TC511000P/J/Z-10  
TC511000P/J/Z-12**

CAS BEFORE RAS REFRESH CYCLE



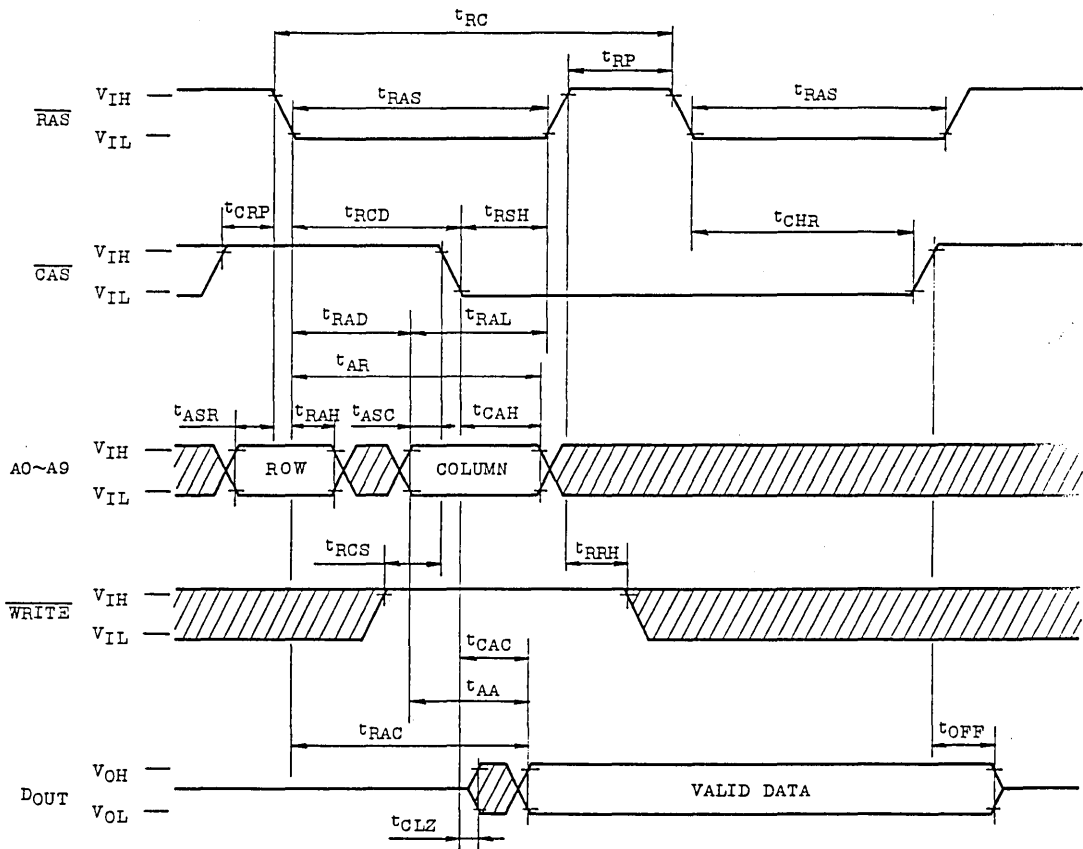
: "H" or "L"


NOTE:  $\overline{WRITE}$ ="H" or "L",  $A0 \sim A9$ ="H" or "L"

"TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

# **TC511000P/J/Z-85, TC511000P/J/Z-10** **TC511000P/J/Z-12**

## HIDDEN REFRESH CYCLE (READ)

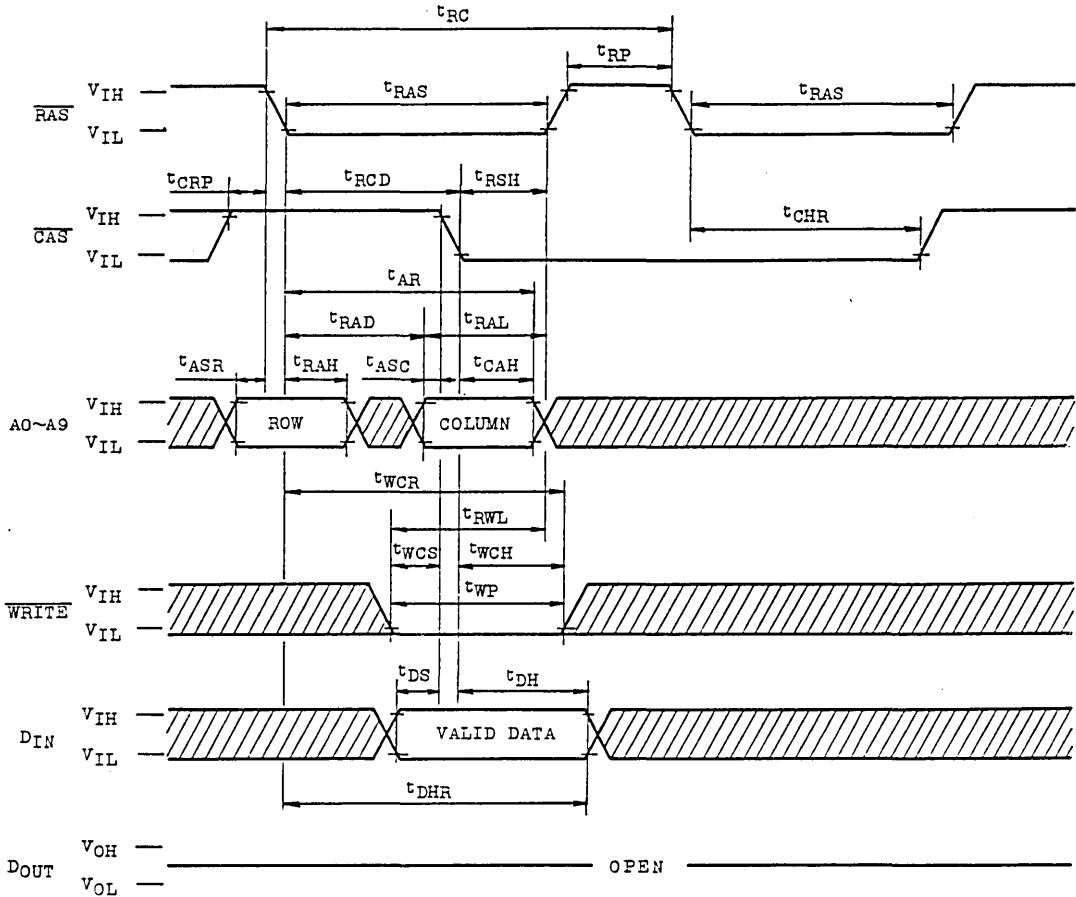


 : "H" or "L"

NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

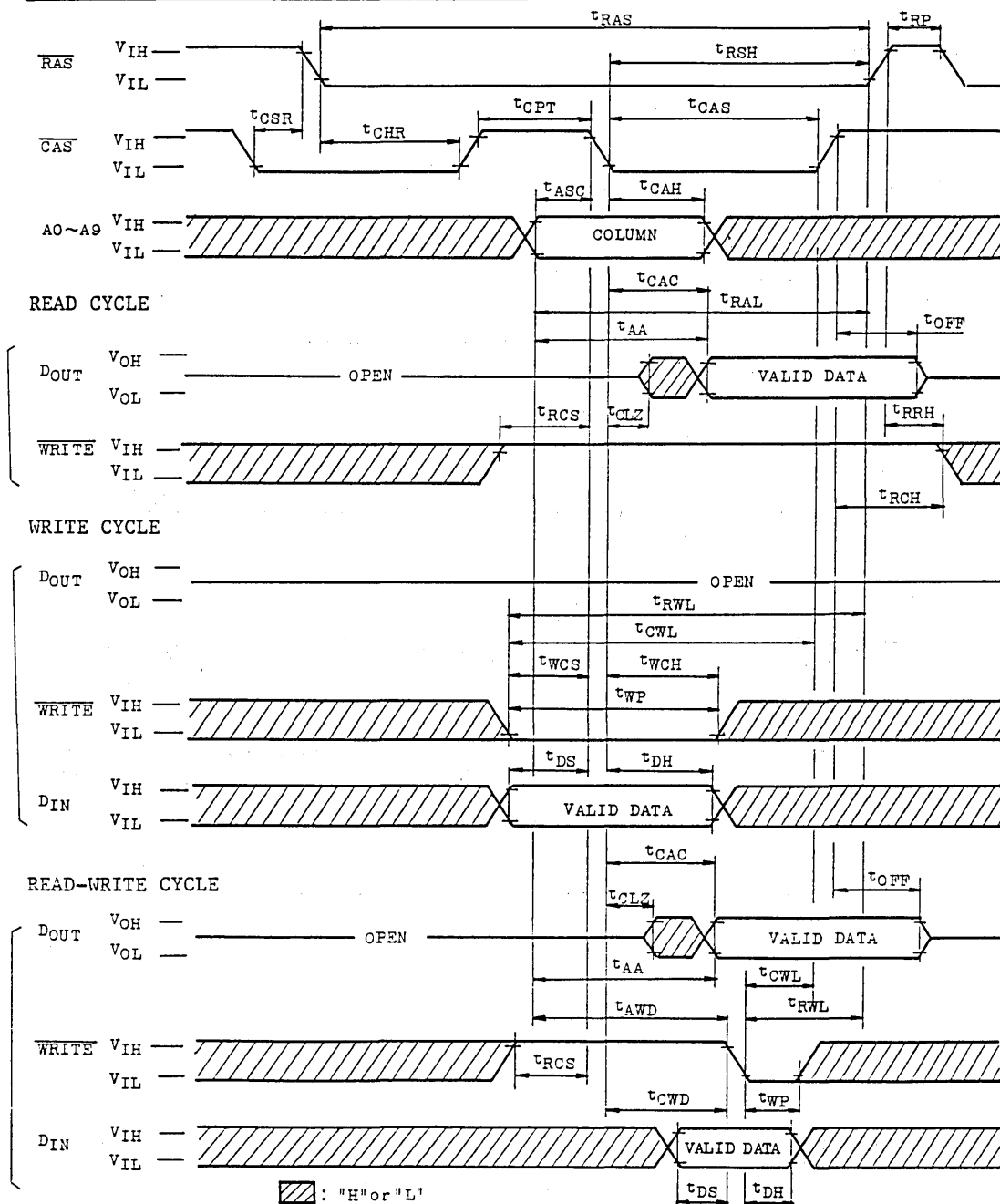
## HIDDEN REFRESH CYCLE (WRITE)



NOTE: "TF" pin should be connected to  $V_{IL}$  level or open, if "Test Mode" is not used.

# **TC511000P/J/Z-85, TC511000P/J/Z-10** **TC511000P/J/Z-12**

## CAS BEFORE RAS REFRESH COUNTER TEST CYCLE



NOTE: "TF" pin should be connected  $V_{IL}$  level or open, if "Test Mode" is not used.



# TC511000P/J/Z-85, TC511000P/J/Z-10 TC511000P/J/Z-12

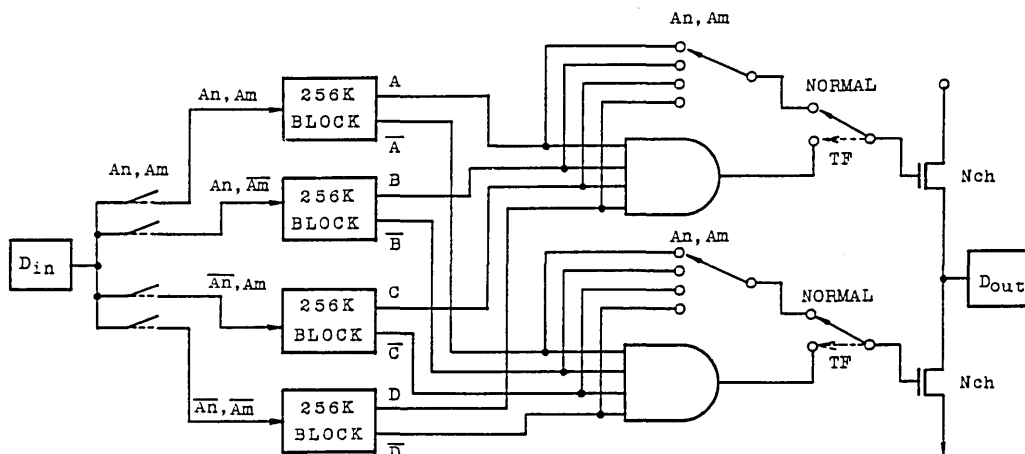
## DESCRIPTION OF THE TEST MODE FOR 1M DRAMS

The TC511000/1/2 is a CMOS DRAM organized as 1,048,576 words by 1-bit. It is internally organized as 262,144 words by 4-bits.

The "Test Mode" function allows for a 1M DRAM to be tested virtually as if it were a 256K DRAM. Figure 1 shows the block diagram of the "Test Mode" circuit. Data is written into the four 256K blocks in parallel and is retrieved the same way. A logical "and" operation is performed on the outputs of the four internal 256K blocks.

- o For a good device, the output data of the four internal blocks are identical to the input data (all "H" or all "L") and consequently the same data will appear on the output pin.
- o For a bad device, the output data of one or more of the internal blocks will differ from the input data and a high impedance state will be detected on the output pin.

### Block Diagram in Test Mode



TF Pin = Super voltage; Test Mode  
TF Pin = Low level or Hi-Z; Normal

### Truth Table in Test mode Function

A	B	C	D	DOUT
0	0	0	0	0
1	1	1	1	1
otherwise				Hi-Z

Fig. 1

# **TC511000P/J/Z-85, TC511000P/J/Z-10** **TC511000P/J/Z-12**

## DESCRIPTION OF THE TEST MODE FOR 1M DRAMS (CONTINUED)

The "Test Mode" function is enabled by applying a "Super Voltage" ( $V_{CC}+4.5V$ , max. voltage=10.5V) on the "TF" pin for a specified period ( $t_{TES}$  and  $t_{TEH}$  as shown in figure 2). It can be used while operating in any mode, including static column mode. It achieves a 4:1 reduction in test time for N patterns and a 16:1 reduction in test time for  $N^2$  patterns. The A9 address input is ignored during the "Test Mode".

During normal operation or when the "Test Mode" function is not used, the "TF" pin must be connected to VSS or TTL Logic Low Level, or left unconnected on the printed wiring board.

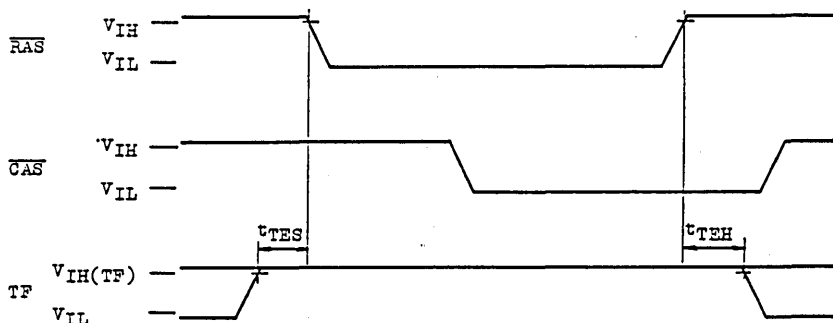
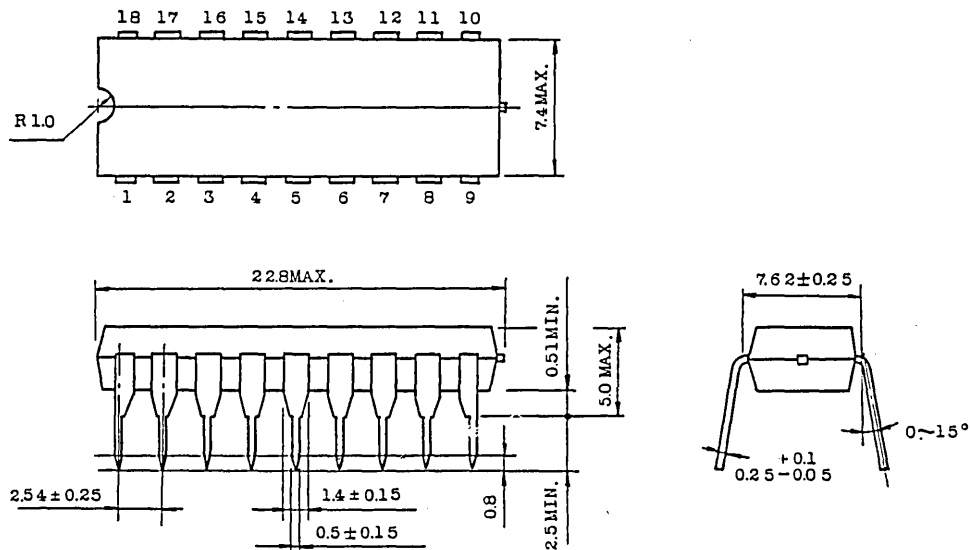


Fig.2 Test Mode Cycle

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• Plastic DIP

Unit in mm



Note: Each lead pitch is 2.54mm.

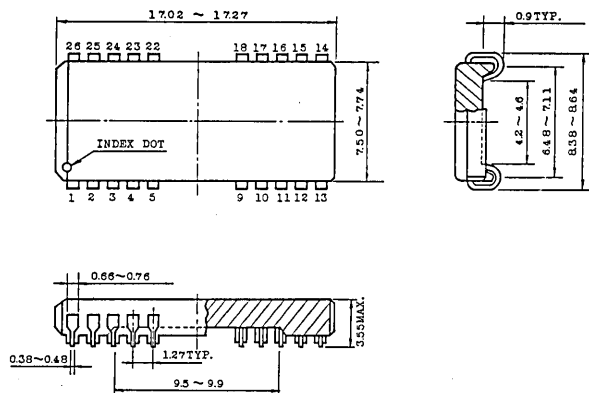
All leads are located within 0.25mm of their true longitudinal position with respect to No.1 and No.18 leads.

All dimensions are in millimeters.

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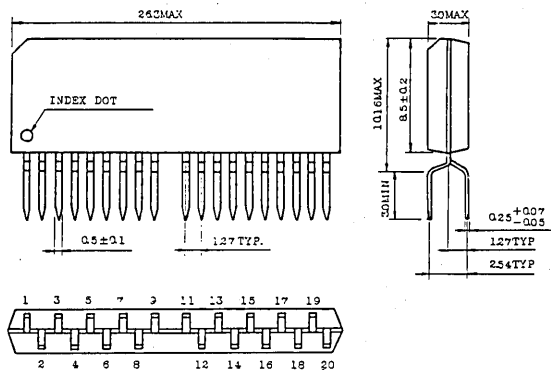
• Plastic SOJ

Unit in mm



• Plastic ZIP

Unit in mm



Note: Each lead pitch is 1.27mm.

All dimensions are in millimeters.

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